

# IRF830B/IRFS830B

## 500V N-Channel MOSFET

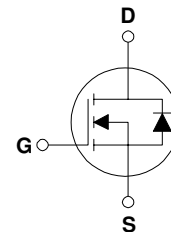
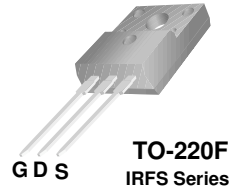
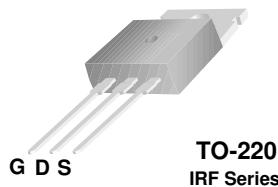
### General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies, power factor correction and electronic lamp ballasts based on half bridge.

### Features

- 4.5A, 500V,  $R_{DS(on)} = 1.5\Omega @ V_{GS} = 10V$
- Low gate charge ( typical 27 nC)
- Low Crss ( typical 17 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	IRF830B	IRFS830	Units
V <sub>DSS</sub>	Drain-Source Voltage	500		V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C) - Continuous (T <sub>C</sub> = 100°C)	4.5	4.5 *	A
		2.9	2.9 *	A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	18	18 *	A
V <sub>GSS</sub>	Gate-Source Voltage	± 30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	270		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	4.5		A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	7.3		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5		V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C) - Derate above 25°C	73	38	W
		0.58	0.3	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		°C

\* Drain current limited by maximum junction temperature

### Thermal Characteristics

Symbol	Parameter	IRF830B	IRFS830B	Units
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case Max.	1.71	3.31	°C/W
R <sub>θCS</sub>	Thermal Resistance, Case-to-Sink Typ.	0.5	--	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient Max.	62.5	62.5	°C/W

## Electrical Characteristics

$T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	500	--	--	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.54	--	V/ $^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$	--	--	10	$\mu\text{A}$
		$V_{DS} = 400\text{ V}, T_C = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 2.25\text{ A}$	--	1.16	1.5	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 2.25\text{ A}$ (Note 4)	--	4.2	--	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	800	1050	pF
$C_{oss}$	Output Capacitance		--	76	100	pF
$C_{rss}$	Reverse Transfer Capacitance		--	17	22	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 250\text{ V}, I_D = 4.5\text{ A},$ $R_G = 25\ \Omega$	--	15	40	ns
$t_r$	Turn-On Rise Time		--	40	90	ns
$t_{d(off)}$	Turn-Off Delay Time		--	85	180	ns
$t_f$	Turn-Off Fall Time		(Note 4, 5)	--	45	100
$Q_g$	Total Gate Charge	$V_{DS} = 400\text{ V}, I_D = 4.5\text{ A},$ $V_{GS} = 10\text{ V}$	--	27	35	nC
$Q_{gs}$	Gate-Source Charge		--	4.0	--	nC
$Q_{gd}$	Gate-Drain Charge		(Note 4, 5)	--	12	--

### Drain-Source Diode Characteristics and Maximum Ratings

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	4.5	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	18	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 4.5\text{ A}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 4.5\text{ A},$	--	305	--	ns
$Q_{rr}$	Reverse Recovery Charge	$di_F / dt = 100\text{ A}/\mu\text{s}$ (Note 4)	--	2.6	--	$\mu\text{C}$

#### Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L = 24\text{mH}, I_{AS} = 4.5\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 4.5\text{ A}, di/dt \leq 300\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\ \mu\text{s}$ , Duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature

Typical Characteristics

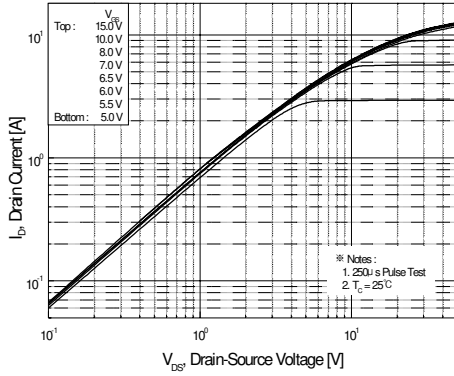


Figure 1. On-Region Characteristics

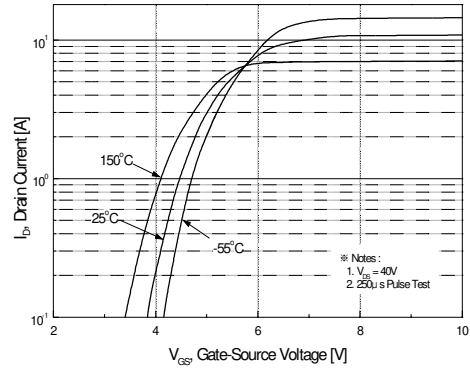


Figure 2. Transfer Characteristics

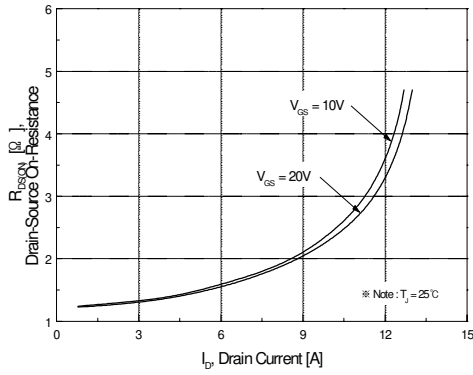


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

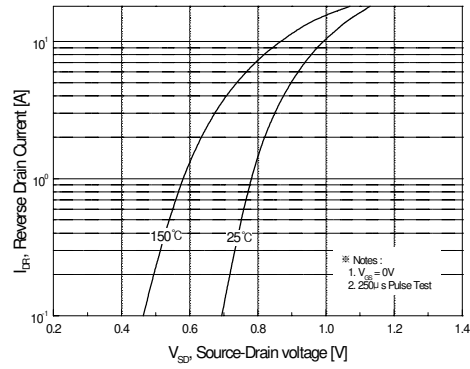


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

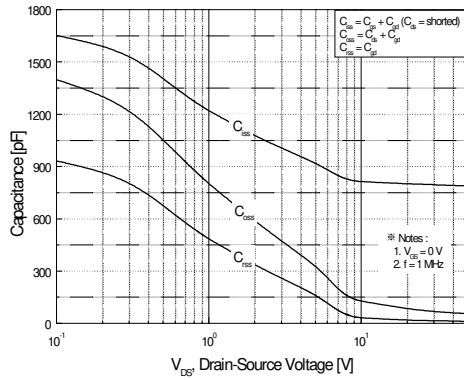


Figure 5. Capacitance Characteristics

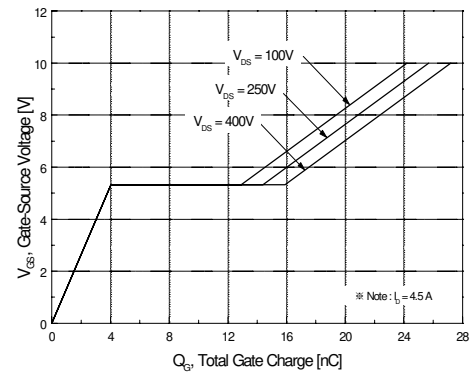


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

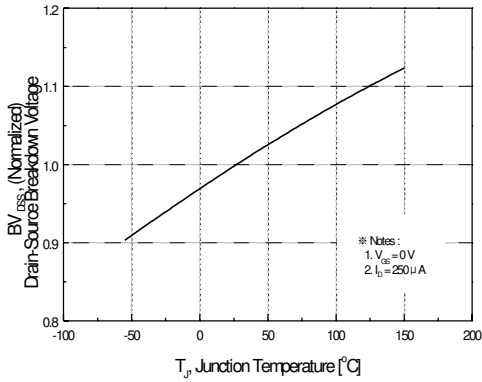


Figure 7. Breakdown Voltage Variation vs Temperature

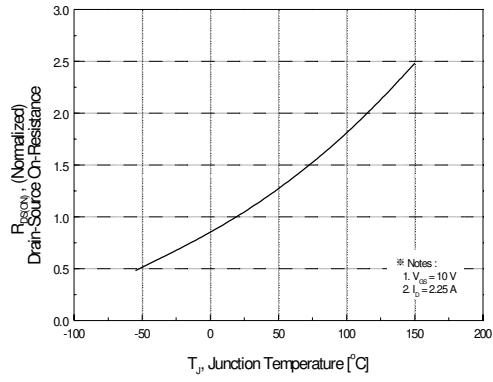


Figure 8. On-Resistance Variation

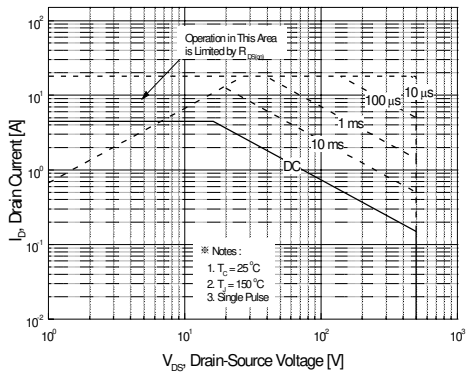


Figure 9-1. Maximum Safe Operating Area for IRF830B

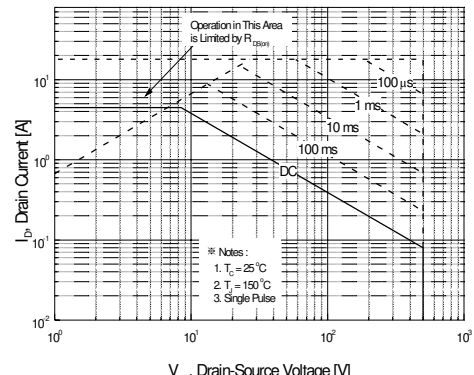


Figure 9-2. Maximum Safe Operating Area for IRFS830B

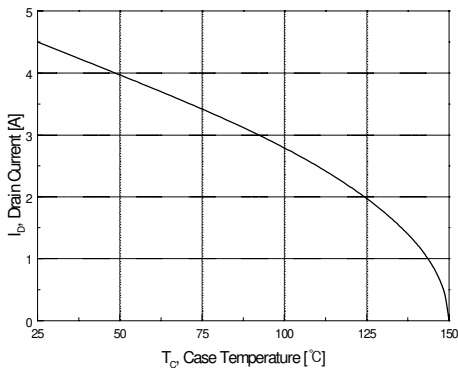


Figure 10. Maximum Drain Current vs Case Temperature

Typical Characteristics (Continued)

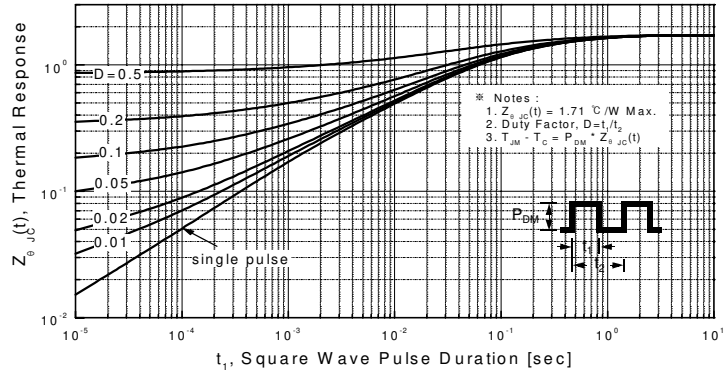


Figure 11-1. Transient Thermal Response Curve for IRF830B

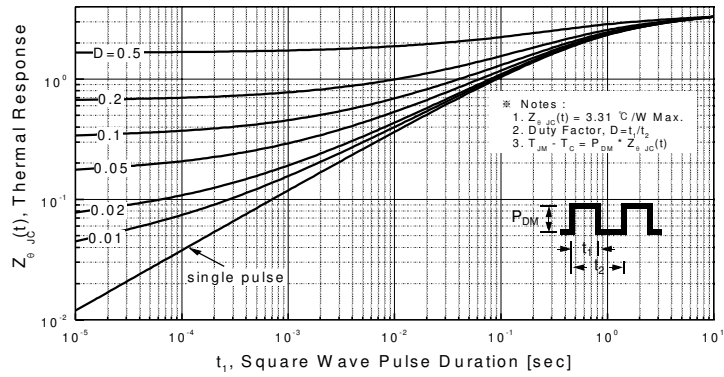
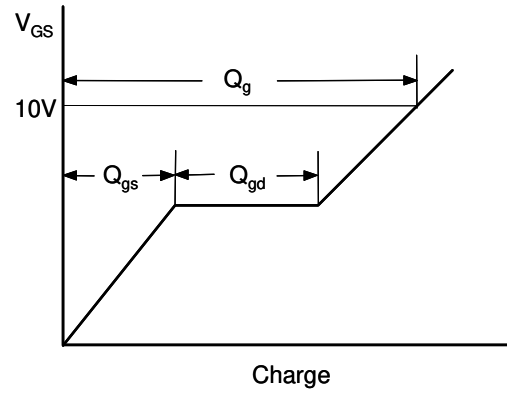
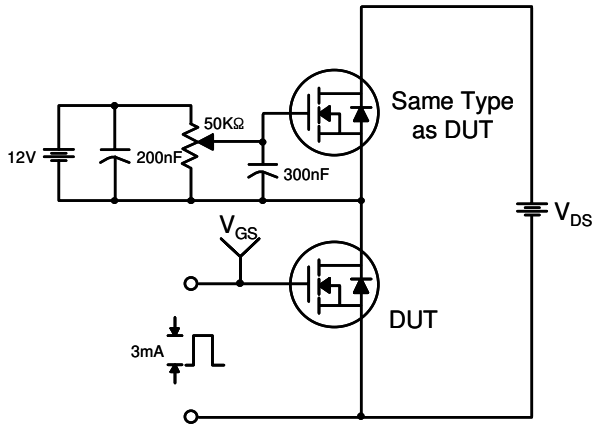
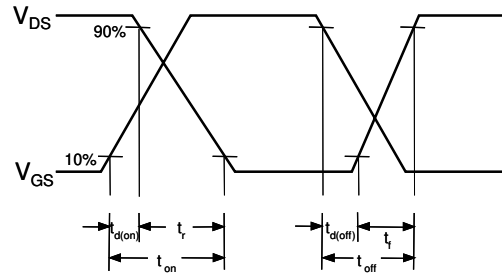
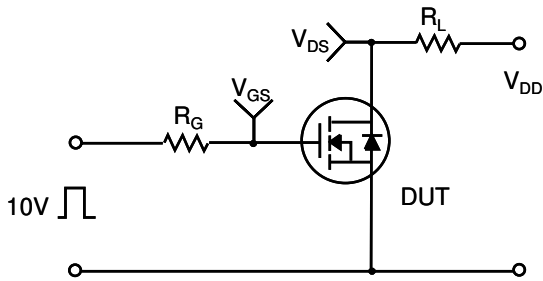


Figure 11-2. Transient Thermal Response Curve for IRFS830B

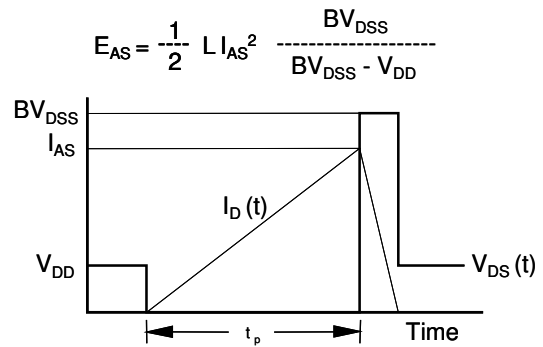
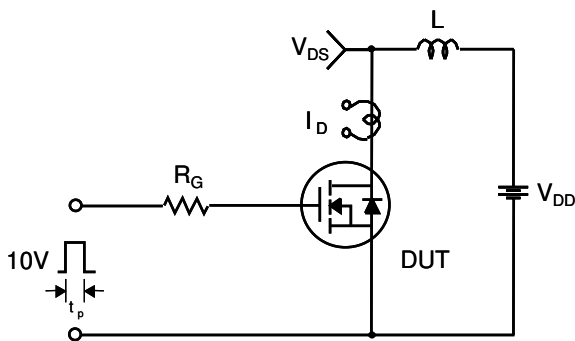
Gate Charge Test Circuit & Waveform



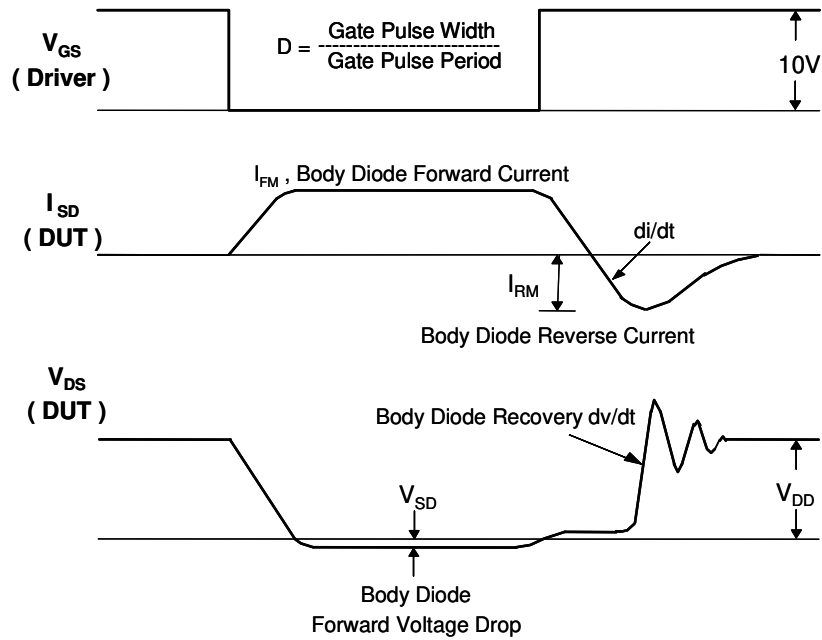
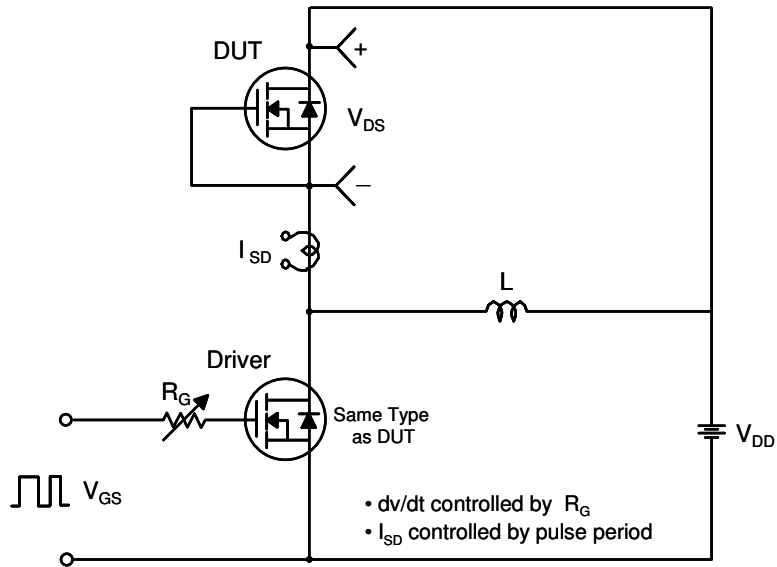
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

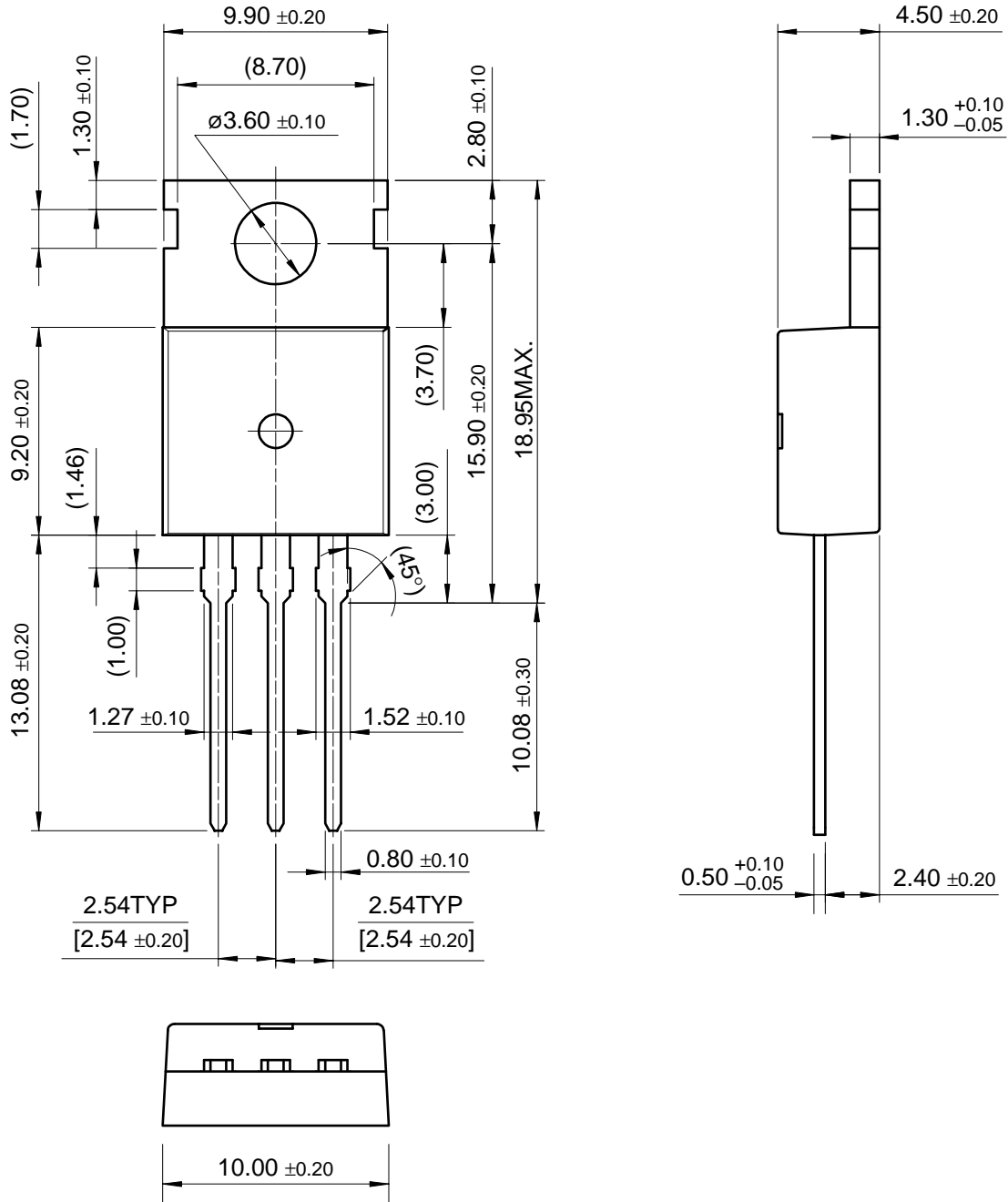


Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions

TO-220

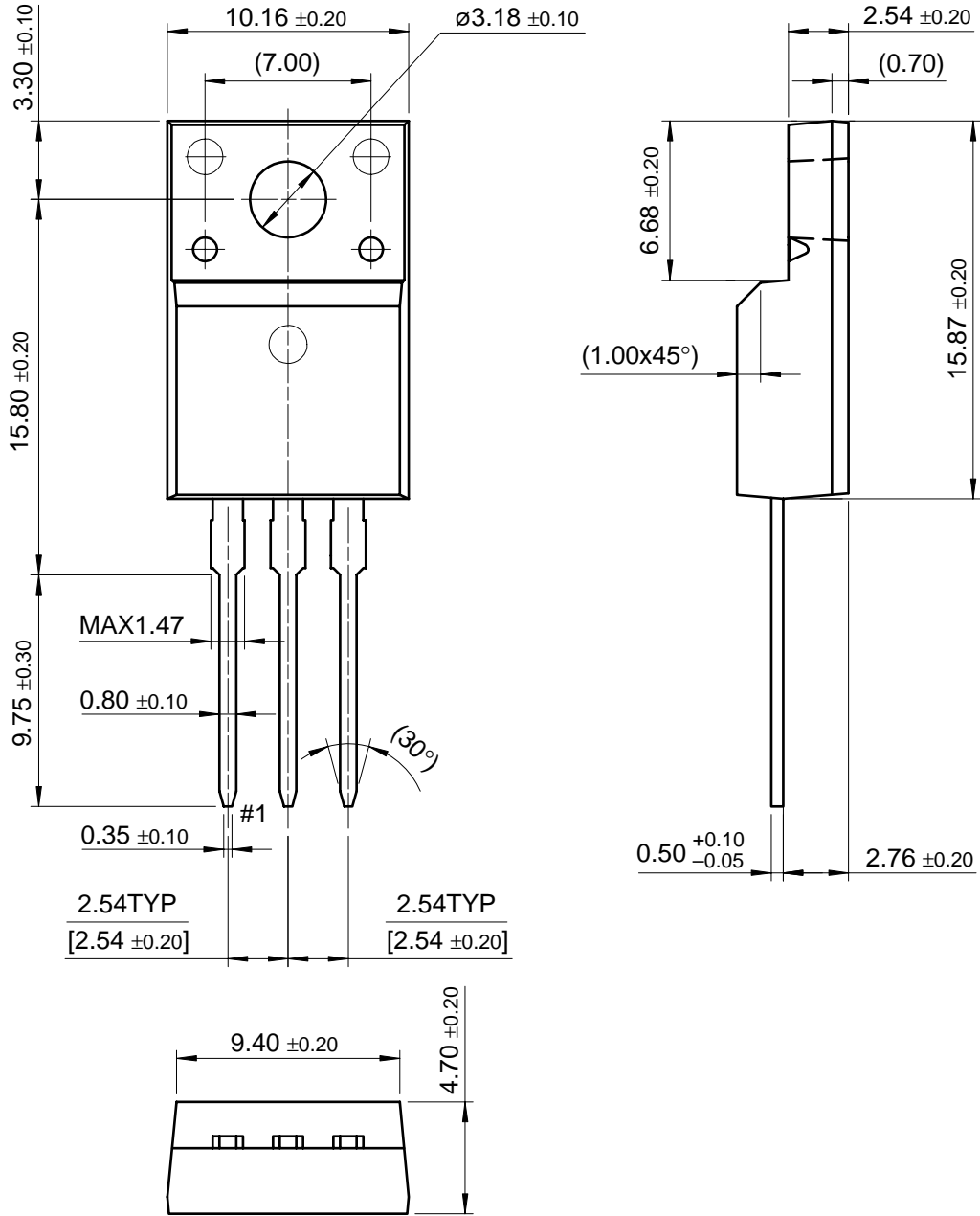


Dimensions in Millimeters



Package Dimensions (Continued)

TO-220F



Dimensions in Millimeters

## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACE <sub>x</sub> <sup>™</sup>	FAST <sup>®</sup>	OPTOLOGIC <sup>™</sup>	SMART START <sup>™</sup>	VCX <sup>™</sup>
Bottomless <sup>™</sup>	FAST <sub>r</sub> <sup>™</sup>	OPTOPLANAR <sup>™</sup>	STAR*POWER <sup>™</sup>	
CoolFET <sup>™</sup>	FRFET <sup>™</sup>	PACMAN <sup>™</sup>	Stealth <sup>™</sup>	
CROSSVOLT <sup>™</sup>	GlobalOptoisolator <sup>™</sup>	POP <sup>™</sup>	SuperSOT <sup>™</sup> -3	
DenseTrench <sup>™</sup>	GTO <sup>™</sup>	Power247 <sup>™</sup>	SuperSOT <sup>™</sup> -6	
DOMET <sup>™</sup>	HiSeC <sup>™</sup>	PowerTrench <sup>®</sup>	SuperSOT <sup>™</sup> -8	
EcoSPARK <sup>™</sup>	ISOPLANAR <sup>™</sup>	QFET <sup>™</sup>	SyncFET <sup>™</sup>	
E <sup>2</sup> CMOS <sup>™</sup>	LittleFET <sup>™</sup>	QS <sup>™</sup>	TruTranslation <sup>™</sup>	
EnSigna <sup>™</sup>	MicroFET <sup>™</sup>	QT Optoelectronics <sup>™</sup>	TinyLogic <sup>™</sup>	
FACT <sup>™</sup>	MicroPak <sup>™</sup>	Quiet Series <sup>™</sup>	UHC <sup>™</sup>	
FACT Quiet Series <sup>™</sup>	MICROWIRE <sup>™</sup>	SLIENT SWITCHER <sup>®</sup>	UltraFET <sup>®</sup>	

STAR\*POWER is used under license

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Fairchild Semiconductor

SEARCH | [Parametric](#) | [Cross Reference](#)

[Product Folders and](#)  [Apply](#)

[find products](#)

[Home](#) >> [Find products](#) >>

[Products groups](#)

[Analog and Mixed](#)

[Signal](#)

[Discrete](#)

[Interface](#)

[Logic](#)

[Microcontrollers](#)

[Non-Volatile](#)

[Memory](#)

[Optoelectronics](#)

[Markets and](#)

[applications](#)

[New products](#)

[Product selection and](#)

[parametric search](#)

[Cross-reference](#)

[search](#)

[technical information](#)

[buy products](#)

[technical support](#)

[my Fairchild](#)

[company](#)

IRFS830B

500V N-Channel B-FET / Substitute of IRFS830 & IRFS830A

Contents

[General description](#) | [Features](#) | [Product status/pricing/packageing](#) | [Application notes](#)

General description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies, power factor correction and electronic lamp ballasts based on half bridge.

[back to top](#)

Features

- 4.5A, 500V
  - $R_{DS(on)} = 1.5\Omega @ V_{GS} = 10 V$
- Low gate charge ( typical 27 nC)
- Low Crss ( typical 17 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

[back to top](#)

Product status/pricing/packageing

Product	Product status	Pricing*	Package type	Leads	Packing method
---------	----------------	----------	--------------	-------	----------------

Related Links

[Request samples](#)

[Dotted line](#)

[How to order products](#)

[Dotted line](#)

[Product Change Notices](#)

[\(PCNs\)](#)

[Dotted line](#)

[Support](#)

[Dotted line](#)

[Distributor and field sales](#)

[representatives](#)

[Dotted line](#)

[Quality and reliability](#)

[Dotted line](#)

[Design tools](#)

Datasheet

[Download this](#)

[datasheet](#)

[PDF](#)

[e-mail this datasheet](#)

[\[E-\]](#)

This page

[Print version](#)

IRFS830B	Full Production	\$0.66	<a href="#">TO-220F</a>	3	RAIL
IRFS830BT	Full Production	\$0.66	<a href="#">TO-220F</a>	3	RAIL

\* 1,000 piece Budgetary Pricing

[back to top](#)

Application notes

[AN-4121: AN-4121 Design of Power Factor Correction Circuit Using FAN7527B](#) (124 K) Jul 19, 2002

[back to top](#)

[Home](#) | [Find products](#) | [Technical information](#) | [Buy products](#) | [Support](#) | [Company](#) | [Contact us](#) | [Site index](#) | [Privacy policy](#)

© Copyright 2002 Fairchild Semiconductor